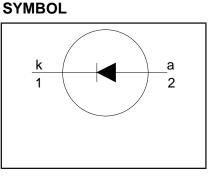
Damper diode fast, high-voltage

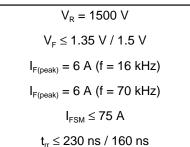
BY329X-1500, BY329X-1500S

FEATURES

- Low forward volt drop
- Fast switching
- Soft recovery characteristic
 High thermal cycling performance
 Isolated mounting tab



QUICK REFERENCE DATA



GENERAL DESCRIPTION

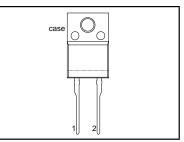
Glass-passivated double diffused rectifier diode featuring low forward voltage drop, fast reverse recovery and soft recovery characteristic. The device is intended for use in TV receivers and PC monitors.

The BY329X series is supplied in the conventional leaded SOD113 package.

PINNING

PTION	PIN
	1
	2
	tab
	2

SOD113



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
V _{RSM}	Peak non-repetitive reverse voltage		-	1500		V
V _{RRM}	Peak repetitive reverse voltage		-	15	00	V
V _{RWM}	Crest working reverse voltage		-	1300		V
		BY329X		-1500	-1500S]
I _{F(peak)}	Peak working forward current	f = 16 kHz f = 70 kHz	-	6 -	- 6	A A
I _{FRM}	Peak repetitive forward current	t = 25 μ s; δ = 0.5; T _{hs} \leq 86 °C	-	14		A
I _{F(RMS)}	RMS forward current		-	1	1	A
I _{FSM}	Peak non-repetitive forward current	t = 10 ms sinusoidal; T _i = 150 °C prior to surge; with reapplied $V_{RWM(max)}$	-	75		A
T _{stg} T _j	Storage temperature Operating junction temperature	surge; with reapplied V _{RWM(max)}	-40 -	150 150		°C C

Damper diode fast, high-voltage

BY329X-1500, BY329X-1500S

ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	R.M.S. isolation voltage from both terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. \leq 65% ; clean and dustfree	-		2500	V
C _{isol}	Capacitance from both terminals to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs} R _{th j-a}	heatsink	with heatsink compound without heatsink compound in free air.	-	- - 55	4.8 5.9 -	K/W K/W K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	TYP.		M	AX.	UNIT
		BY329X-	1500	1500S	1500	1500S	
V _F	Forward voltage	I _F = 6.5 A I _F = 6.5 A; T _i = 125 °C	1.1 1.05	1.3 1.2	1.45 1.35	1.6 1.5	V V
I _R	Reverse current	V _R = 1300 V V _R = 1300 V; T _j = 125 °C	-	250 1	-	250 1	μA mA

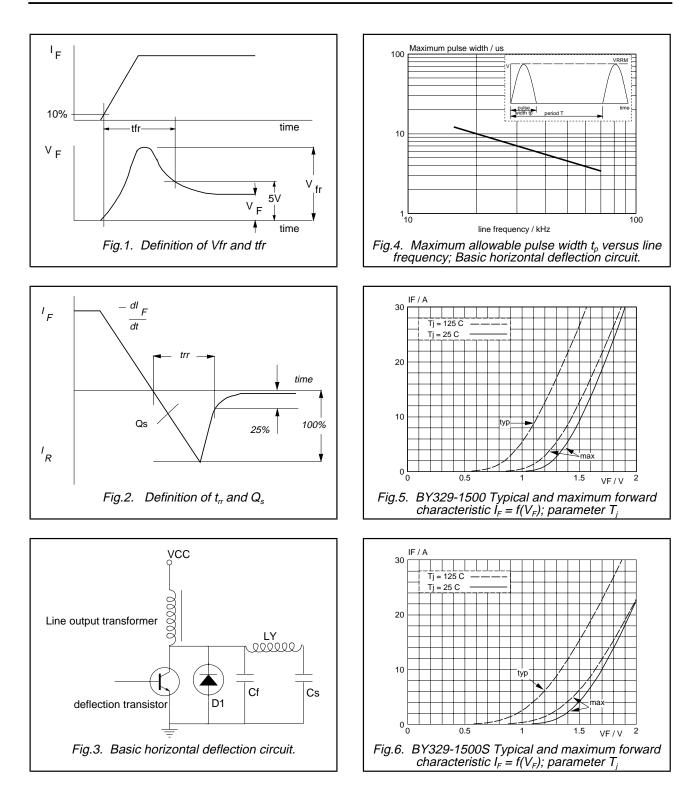
DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	TYP.		DITIONS TYP. MAX.			AX.	UNIT
		BY329X	1500	1500S	1500	1500S			
t _{rr}	Reverse recovery time	$\begin{array}{l} I_{\text{F}} = 1 \hspace{0.1 cm} A; \hspace{0.1 cm} V_{\text{R}} \geq 30 \hspace{0.1 cm} V; \\ dI_{\text{F}}/dt = 50 A/\mu s \end{array}$	0.18	0.13	0.23	0.16	μs		
$\begin{matrix} Q_s \\ V_{fr} \\ t_{fr} \end{matrix}$	Reverse recovery charge Peak forward recovery voltage Forward recovery time	$ \begin{split} I_F &= 2 \text{ A}; \ \text{-d}I_F/\text{d}t = 20 \text{ A}/\mu\text{s} \\ I_F &= 6.5\text{A}; \ \text{d}I_F/\text{d}t = 50\text{A}/\mu\text{s} \\ I_F &= 6.5\text{A}; \ \text{d}I_F/\text{d}t = 50\text{A}/\mu\text{s} \end{split} $	1.6 17 210	0.7 23 220	2.0 30 300	0.95 40 320	μC V ns		

Damper diode fast, high-voltage

BY329X-1500, BY329X-1500S

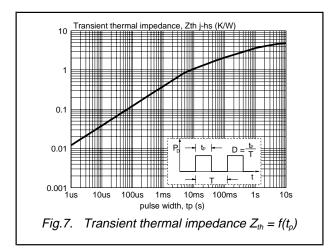


Philips Semiconductors

Product specification

Damper diode fast, high-voltage

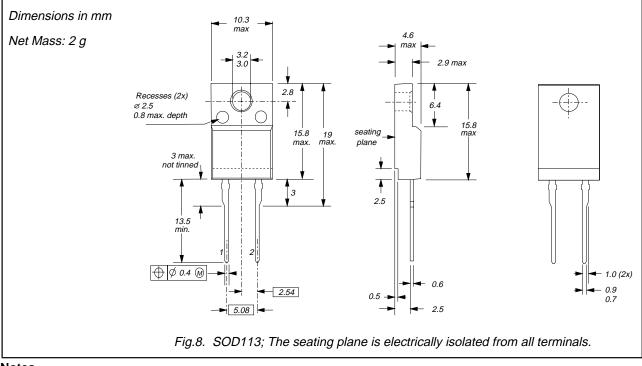
BY329X-1500, BY329X-1500S



Damper diode fast, high-voltage

BY329X-1500, BY329X-1500S

MECHANICAL DATA



Notes

Refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

Damper diode fast, high-voltage

BY329X-1500, BY329X-1500S

DEFINITIONS

Data sheet status						
Objective specification	bjective specification This data sheet contains target or goal specifications for product development.					
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.					
Product specification	This data sheet contains final product specifications.					
Limiting values						
or more of the limiting val operation of the device at this specification is not im	in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one ues may cause permanent damage to the device. These are stress ratings only and these or at any other conditions above those given in the Characteristics sections of applied. Exposure to limiting values for extended periods may affect device reliability.					
Application information						
Where application inform	ation is given, it is advisory and does not form part of the specification.					
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LIFE SUPPORT APPLICATIONS

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